
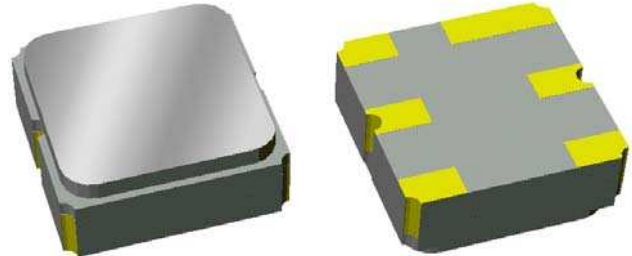


# Data Sheet

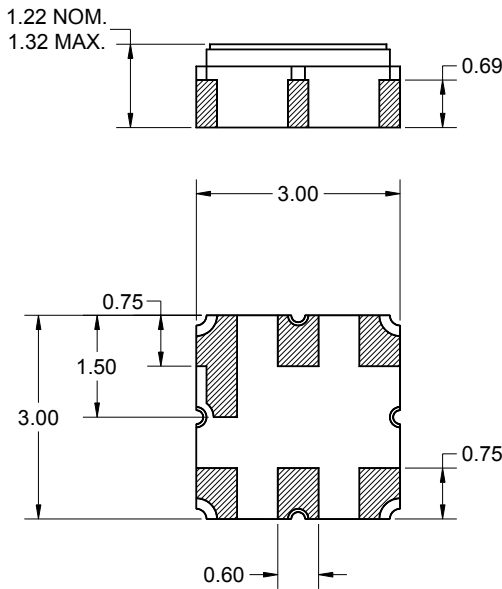
## Features

- For AMPS, CDMA and TDMA applications
- Usable bandwidth 25 MHz
- Low loss
- No impedance matching required for operation at 50 Ω
- Single-ended operation
- Ceramic Surface Mount Package (SMP)
- Hermetic
- RoHS compliant (2002/95/EC), Pb-free 



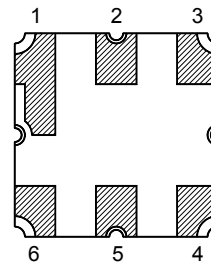
## Package

Surface Mount 3.00 x 3.00 x 1.22 mm



## Pin Configuration

Bottom View



Pin No.	Description
2,5	Input/Output
1,3,4,6	Case ground

Dimensions shown are nominal in millimeters  
 All tolerances are ±0.15mm except overall length and width ±0.10mm

Body:  $Al_2O_3$  ceramic  
 Lid: Kovar, Ni plated  
 Terminations: Au plating 0.5 - 1.0μm,  
 over a 2 - 6μm Ni plating

# Data Sheet

## Electrical Specifications <sup>(1)</sup>

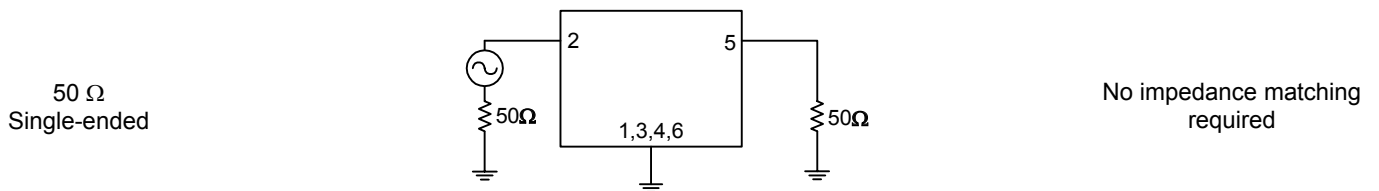
Operating Temperature Range: <sup>(2)</sup> -40 to +85 °C

Parameter <sup>(3)</sup>	Minimum	Typical	Maximum	Unit
<b>Center Frequency</b>	-	836.5	-	MHz
<b>Maximum Insertion Loss</b> 824 - 849 MHz	-	1.9	3	dB
<b>Amplitude Variation</b> 824 - 849 MHz	-	0.8	1.5	dB p-p
<b>Absolute Attenuation</b> 10 - 800 MHz	25	30	-	dB
869 - 894 MHz	35	40	-	dB
978 - 1006 MHz	25	35	-	dB
1050 - 2600 MHz	20	28	-	dB
<b>Input/Output Return Loss</b> 824 - 849 MHz	10	14	-	dB
<b>Source Impedance <sup>(4)</sup></b>	-	50	-	Ω
<b>Load Impedance <sup>(4)</sup></b>	-	50	-	Ω

**Notes:**

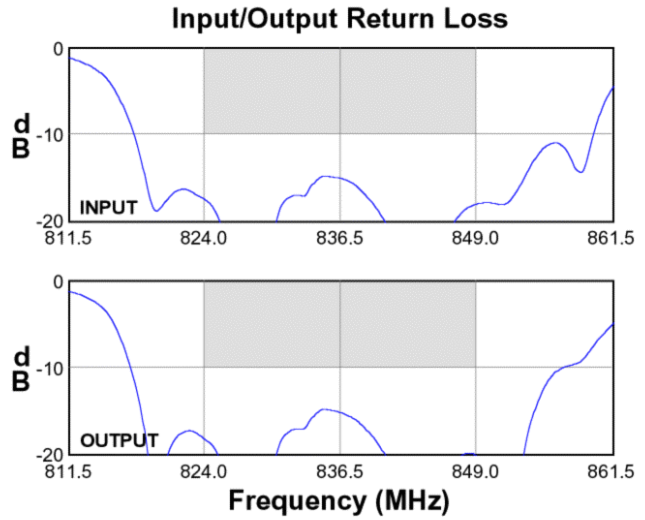
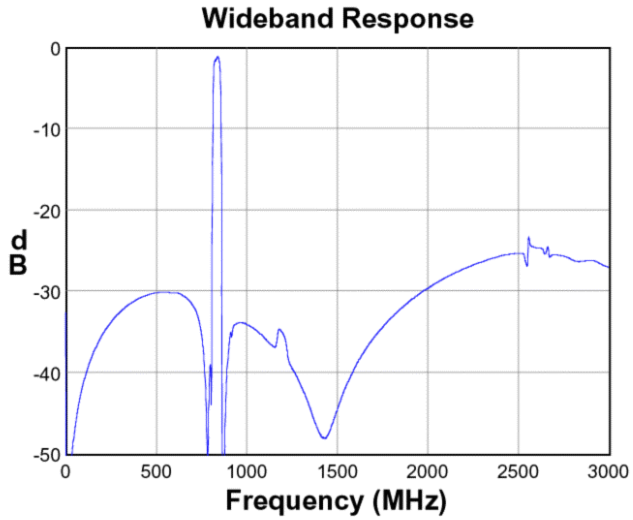
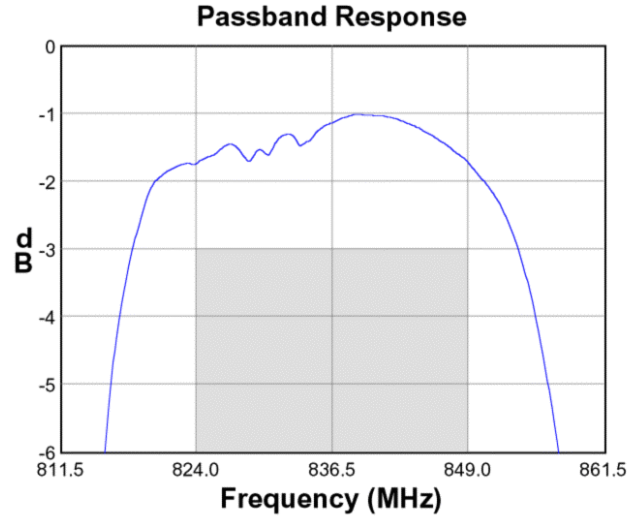
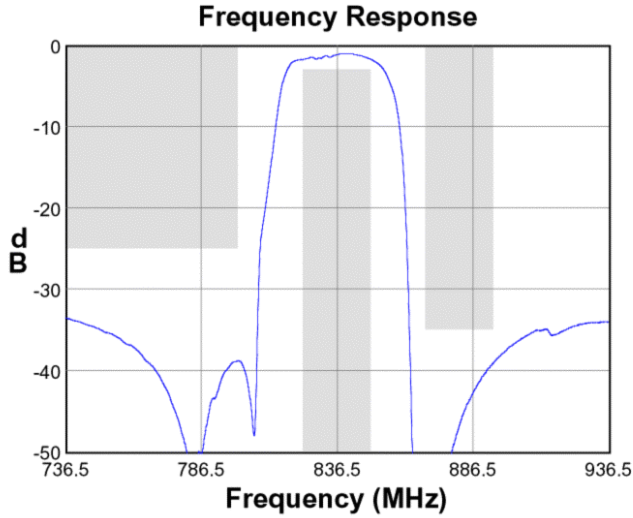
1. All specifications are based on the test circuit shown below
2. In production, devices will be tested at room temperature to a guardbanded specification to ensure electrical compliance over temperature
3. Electrical margin has been built into the design to account for the variations due to temperature drift and manufacturing tolerances
4. This is the optimum impedance in order to achieve the performance shown

**Test Circuit:**

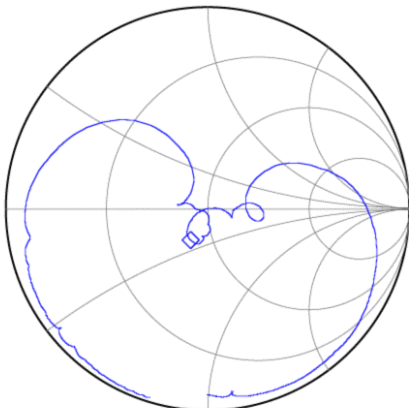


**Data Sheet**

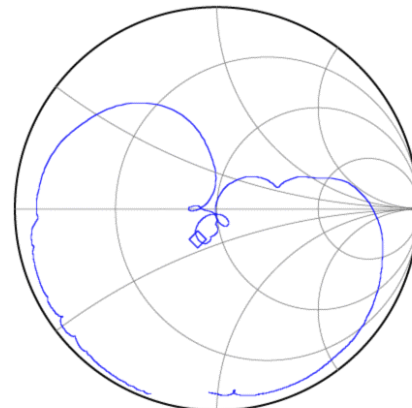
**Typical Performance (at +25°C)**



**Input Smith Chart**



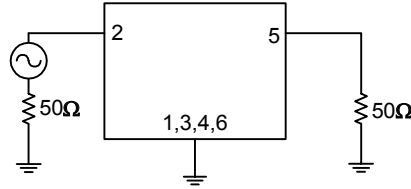
**Output Smith Chart**



**Data Sheet**

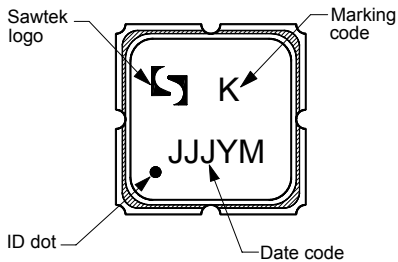
**Matching Schematics**

50 Ω  
Single-ended



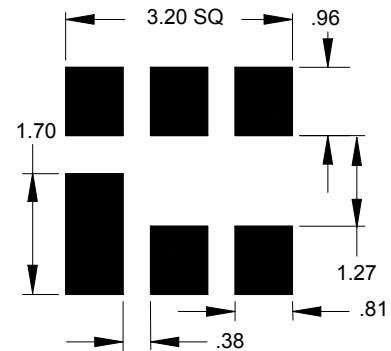
No impedance matching  
required

**Marking**



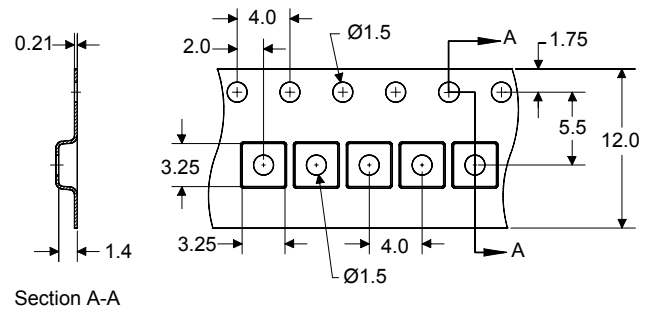
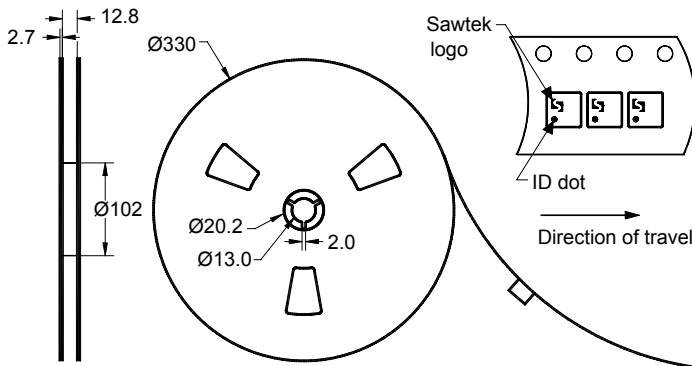
The date code consists of: JJJ = Julian day,  
Y = last digit of year, M = manufacturing site code

**PCB Footprint**



This footprint represents a recommendation only  
Dimensions shown are nominal in millimeters

**Tape and Reel**



Dimensions shown are nominal in millimeters  
Packaging quantity: 5000 units/reel


# Data Sheet

## Maximum Ratings


Parameter	Symbol	Minimum	Maximum	Unit
Operating Temperature Range	T	-40	+85	°C
Storage Temperature Range	T <sub>stg</sub>	-40	+85	°C
RF Power	P <sub>in</sub>	-	+23	dBm

## Important Notes

### Warnings

- Electrostatic Sensitive Device (ESD) 
- Avoid ultrasonic exposure

### RoHS Compliance

- This product complies with EU directive 2002/95/EC (RoHS) 

### Solderability

- Compatible with JEDEC J-STD-020C **Pb**-free process, **260°C** peak reflow temperature ([see soldering profile](#))

## Links to Additional Technical Information

[PCB Layout Tips](#)

[Qualification Flowchart](#)

[Soldering Profile](#)

[S-Parameters](#)

[RoHS Information](#)

[Other Technical Information](#)

Sawtek's liability is limited only to the Surface Acoustic Wave (SAW) component(s) described in this data sheet. Sawtek does not accept any liability for applications, processes, circuits or assemblies, which are implemented using any Sawtek component described in this data sheet.

## Contact Information



PO Box 609501  
 Orlando, FL 32860-9501  
 USA

Phone: +1 (407) 886-8860  
 Fax: +1 (407) 886-7061  
 Email: [custservice@sawtek.com](mailto:custservice@sawtek.com)  
 Web: [www.sawtek.com](http://www.sawtek.com)

Or contact one of our worldwide  
 Network of [sales offices](#),  
[representatives or distributors](#)